

**System in Package (SiP) Die Market Size, Share & Trends Analysis Report By Type
(2D SiP Die, 2.5D SiP Die, 3D SiP Die), By Applications (Consumer Electronics,
Telecommunications, Automotive, Industrial, Healthcare, Others), By End-User
(Electronics Manufacturers, Automotive OEMs, Medical Device Companies, Others)
and By Region(North America, Europe, APAC, Middle East and Africa, LATAM)
Forecasts, 2024-2032**

Market Report | 2024-05-27 | 0 pages | Straits Research

To place an Order with Scotts International:

- ☐ - Print this form
- ☐ - Complete the relevant blank fields and sign
- ☐ - Send as a scanned email to support@scotts-international.com

ORDER FORM:

Select license	License	Price
	Single User License	\$4500.00
	Global Site License	\$5500.00
	VAT	
	Total	

*Please circle the relevant license option. For any questions please contact support@scotts-international.com or 0048 603 394 346.

** VAT will be added at 23% for Polish based companies, individuals and EU based companies who are unable to provide a valid EU Vat Numbers.

Email*		Phone*	
First Name*		Last Name*	
Job title*			
Company Name*		EU Vat / Tax ID / NIP number*	

Scotts International. EU Vat number: PL 6772247784

tel. 0048 603 394 346 e-mail: support@scotts-international.com

www.scotts-international.com

Address*		City*	
Zip Code*		Country*	
		Date	2026-02-22
		Signature	